

國家生技研究園區創服育成中心

進駐申請表(公司)

Application For Leasing Incubation Suite, NBRP

申請日期：vvvv/mm/dd

| 一、申請公司基本資料/ Applicant Basic Information | | | |
|---|--|------------------------------------|--|
| 公司中英文名稱 Company Name (Chinese and English) | | | |
| 公司地址 Company Address | | | |
| 公司統一編號 Incorporation Registration No. | | 公司成立日期 Date Established | |
| 實收資本額 Paid-in-Capital | NTD\$ | 聯絡人 Contact Person | |
| 負責人 Person in Charge | | 連絡電話 Telephone No. | |
| 總經理 CEO | | 聯絡人 E-mail E-mail Address | |
| 二、申請設施需求/ Facility and Extraordinary Needs | | | |
| 申請日期 Application Date | | 擬進駐人數 Number of Team Members | |
| 預定進駐期間 Anticipated Period | _____年_____月至_____年_____月 (以三年為限) From _____ (M/Y) to _____ (M/Y) (Max. 3 yrs.) | | |
| 面積需求 Space Requested : | | | |
| 電力/用水量/公共設備 Electric Power / Water Supply / Common Equipment : | | | |
| 特殊安全/廢棄物處理需求 Special Safety and Waste Disposal Needs : | | | |

其他 Others :

三、檢附證件/ Submitted Document Checklist

- 公司登記證影本 Photocopy of Incorporation Registration Certificate
- 與本園區簽訂之授權/合作契約書 (無授權或合作者免附)
Collaborative R&D / Licensing Agreements with NBRP
- 與其他單位簽訂之授權/合作契約書 (無授權或合作者免附)
Collaborative R&D / Licensing Agreements with Other Entities
- 營運計畫書 Business Plan
- 進駐計畫/ Admission plan
- 其他附件 Supplement Materials

四、承諾書/ Letter of Undertaking

申請人保證本計畫不侵害他人之專利權、專門技術及著作權等相關智慧財產權，並保證下列事項均屬實，否則願負一切責任：

- 1、本申請書所述資料均正確。
- 2、申請人提交營運計畫構想書，同意供審查委員會進行各項資格審查。
- 3、申請人過去三年內未曾被法院判決確定有侵害他人智慧財產權。
- 4、申請人過去三年內所曾接受政府之相關專案輔導、委託或合作計畫，均無不良紀錄。

I, the applicant, declare that the proposed project does not intentionally infringe other people's intellectual property rights and guaranties that the followings are truthful to the best of my knowledge. If falsified, I will bear all the legal responsibilities.

1. All answers in this application are true.
2. The applicant agrees to allow the business plan to be reviewed in full.
3. The applicant was not convicted by court for infringing the third party's intellectual property rights in the past three years.
4. The applicant has no delinquent records in dealing with government sponsoring projects in the past three years.

(請負責人於本欄位親簽並加蓋公司印章)
(Signature of principal and company seals)

以下為國家生技研究園區創服育成中心建檔之用，廠商不需填寫/ Leave Blank

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|------|-------|------|-------|
| 回件地址 | | | |
| 收文日 | 年 月 日 | 申請日期 | 年 月 日 |
| 收文字號 | | 發文字號 | |